

0905028099

*AUTO EQUIPMENT
SOLUTION PROVIDER*

萬潤科技

AllRing Tech

Stock Code:6187.TT



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公司簡介

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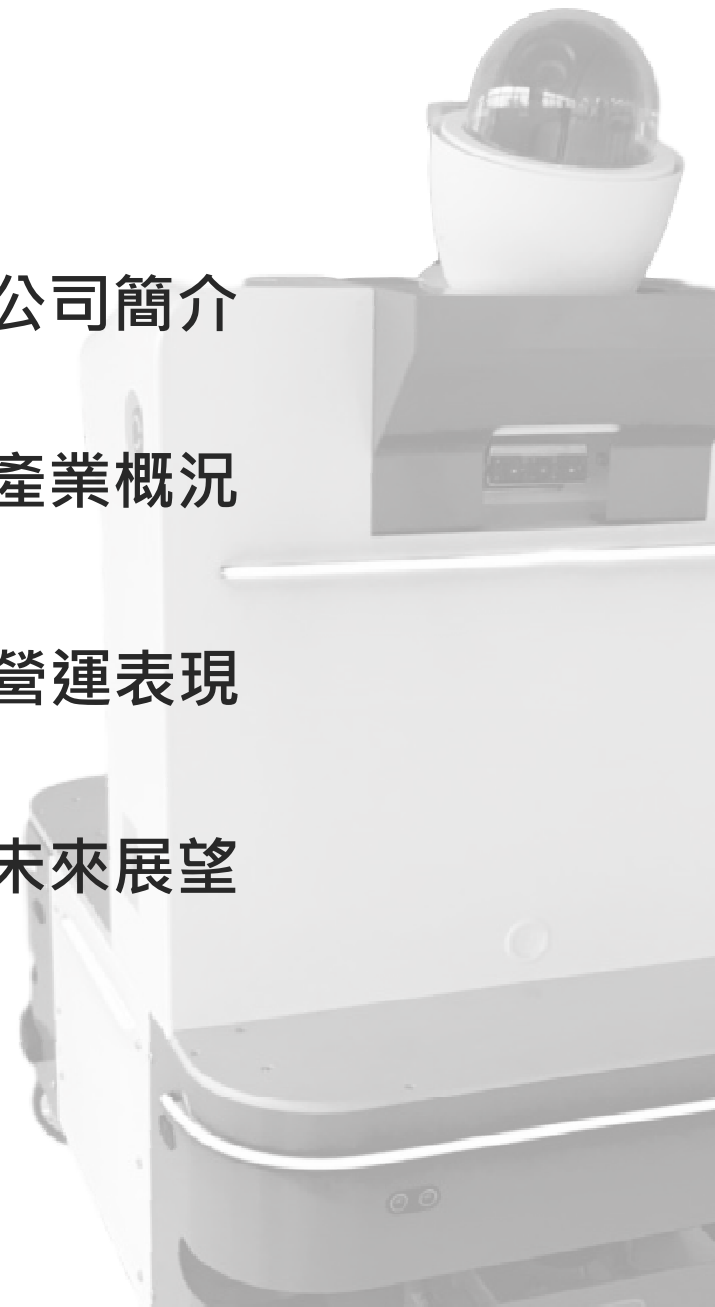
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Disclaimer

This report and released message contains information about corporate prospects, financial updates and sales forecasts, established on the basis of internal resources and external reference sharing. The actual performance may be different from expressed or implied predictions due to uncontrollable and/or unpredictable risks.

All prospects reflect Allring-tech expectations toward the future, and may be subject to change and Allring-tech reserves the right to alter, update and change relevant information from time to time without prior notice.



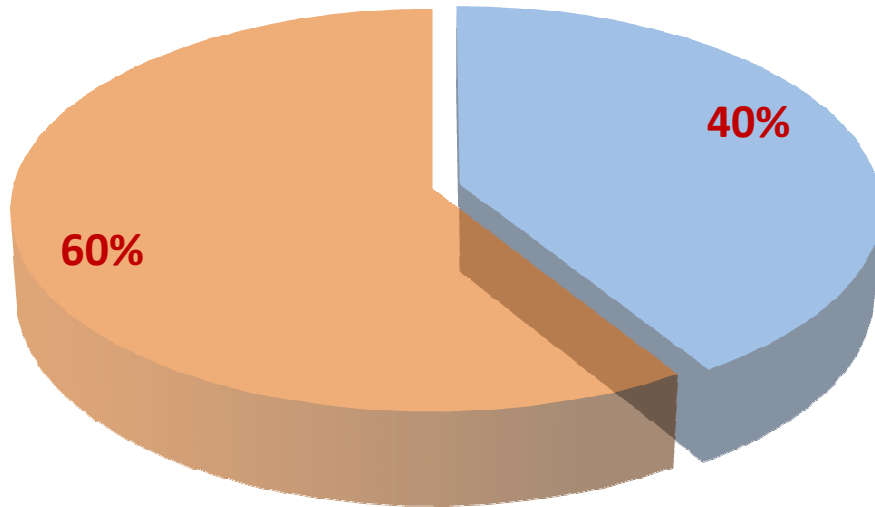
公司簡介



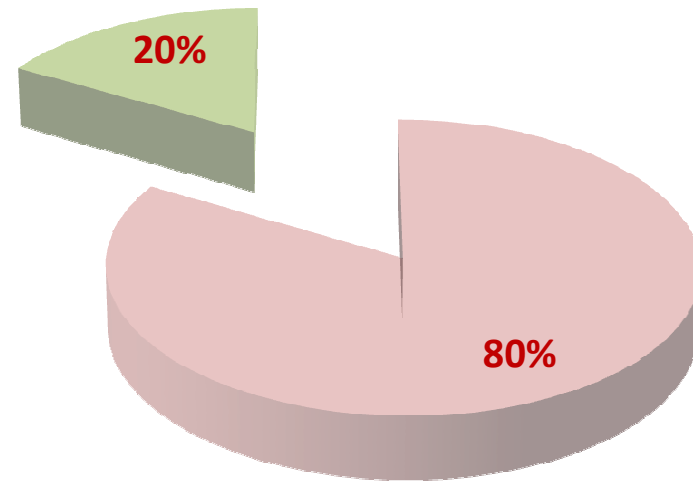
Company Profile

Established	May 24, 1996
Capital	NTD 833 Million (USD 27 Million)
Business	Automation equipment supplier for Semiconductor test & package, Passive Component manufacturing and LED back-end industries
Employee	205 (Feb, 2019)
Chairman	Larry Lu
Address	No.1 Luke 10th Rd. ,Lujhu,Kaohsiung,Taiwan
Website	www.allring-tech.com.tw

Human Resources- R&D Background



- Hardware
- Software



- Motion Programming
- Visual System

Core Tech – Dispensing Pump

Dispensing
Control

0.1mg ±5%

INK- Jet Printer

Piezoelectric Jetting Pump

Jetting
Pump

Linear Pump

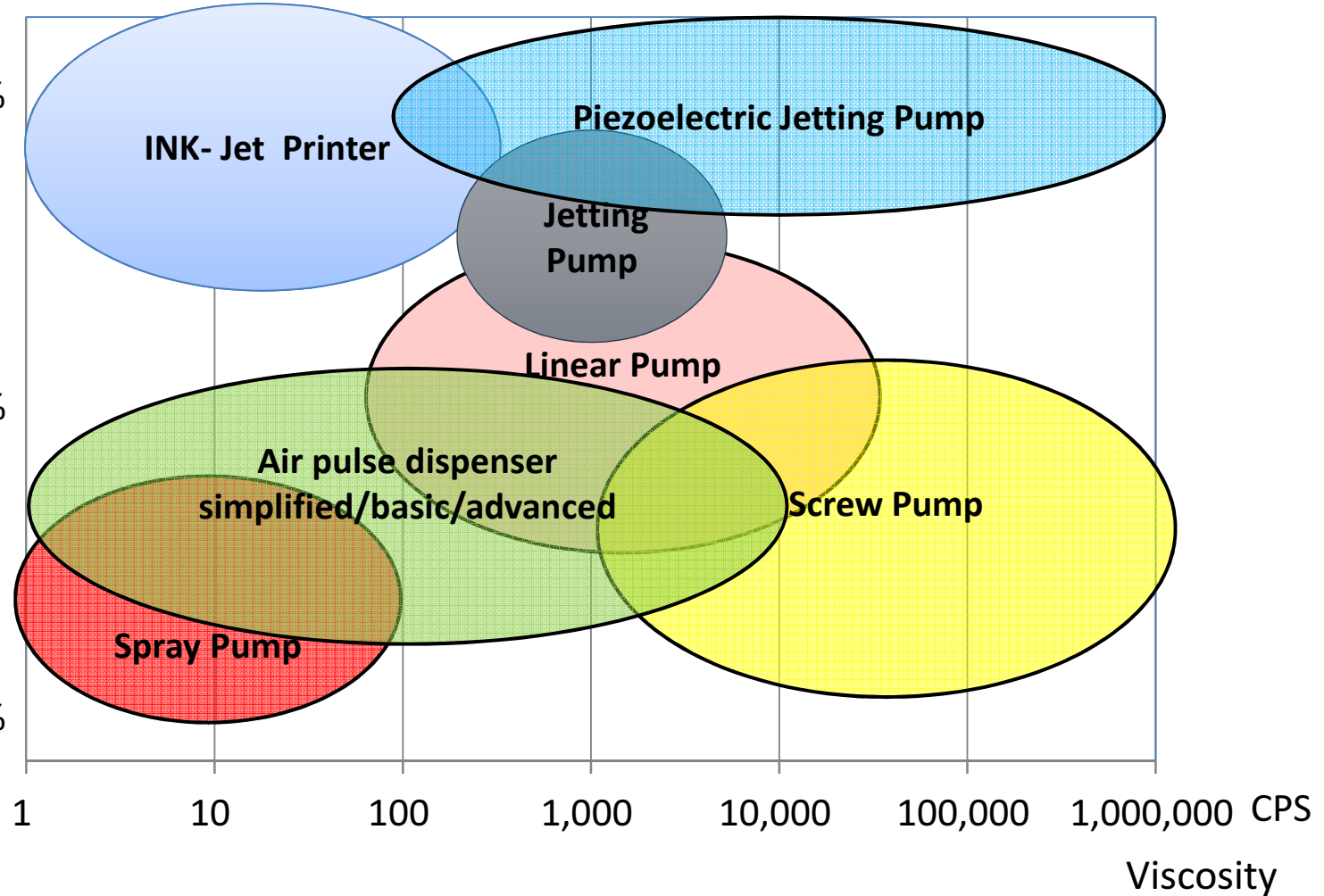
1mg ±5%

Air pulse dispenser
simplified/basic/advanced

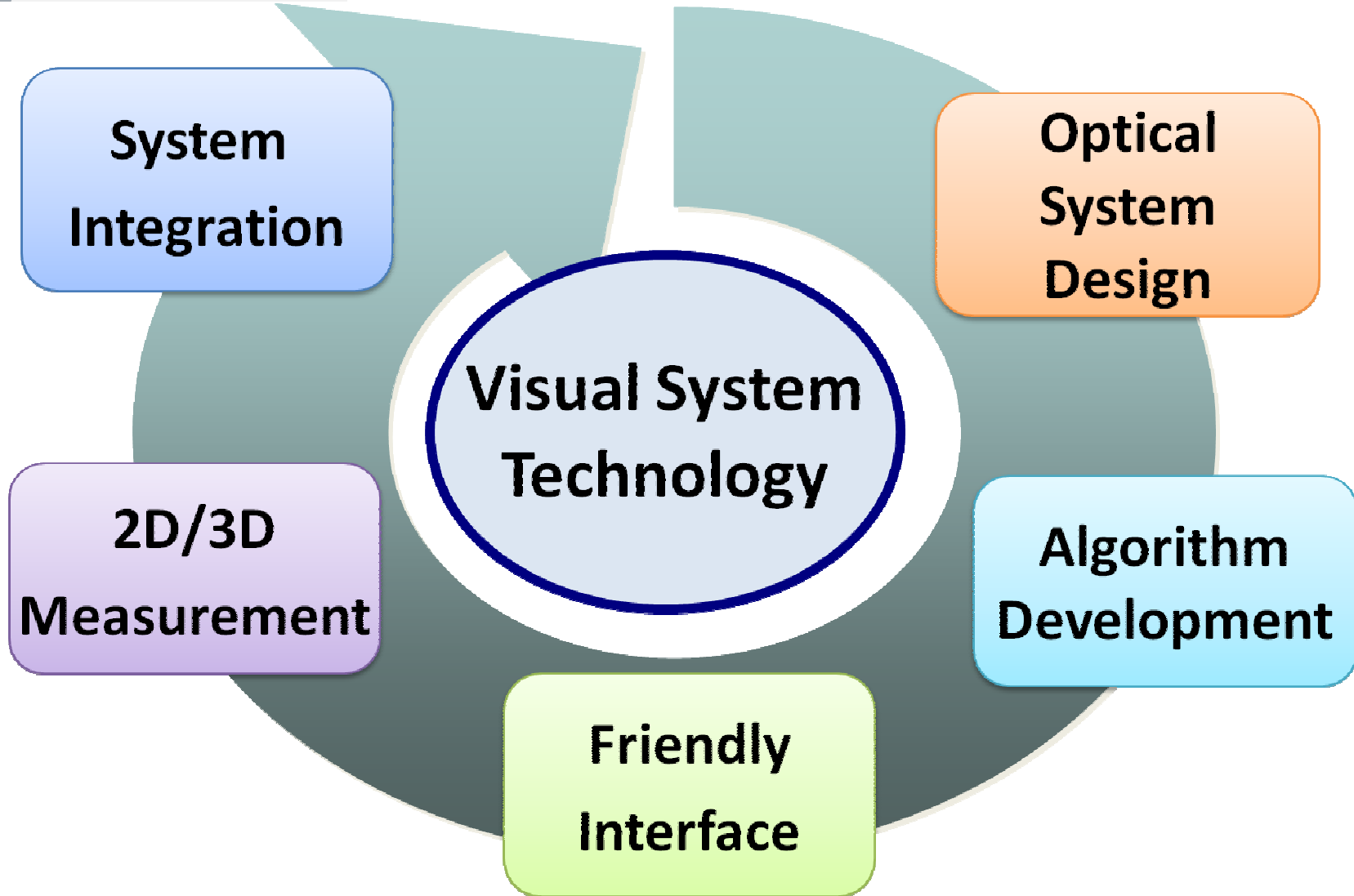
Screw Pump

10mg ±5%

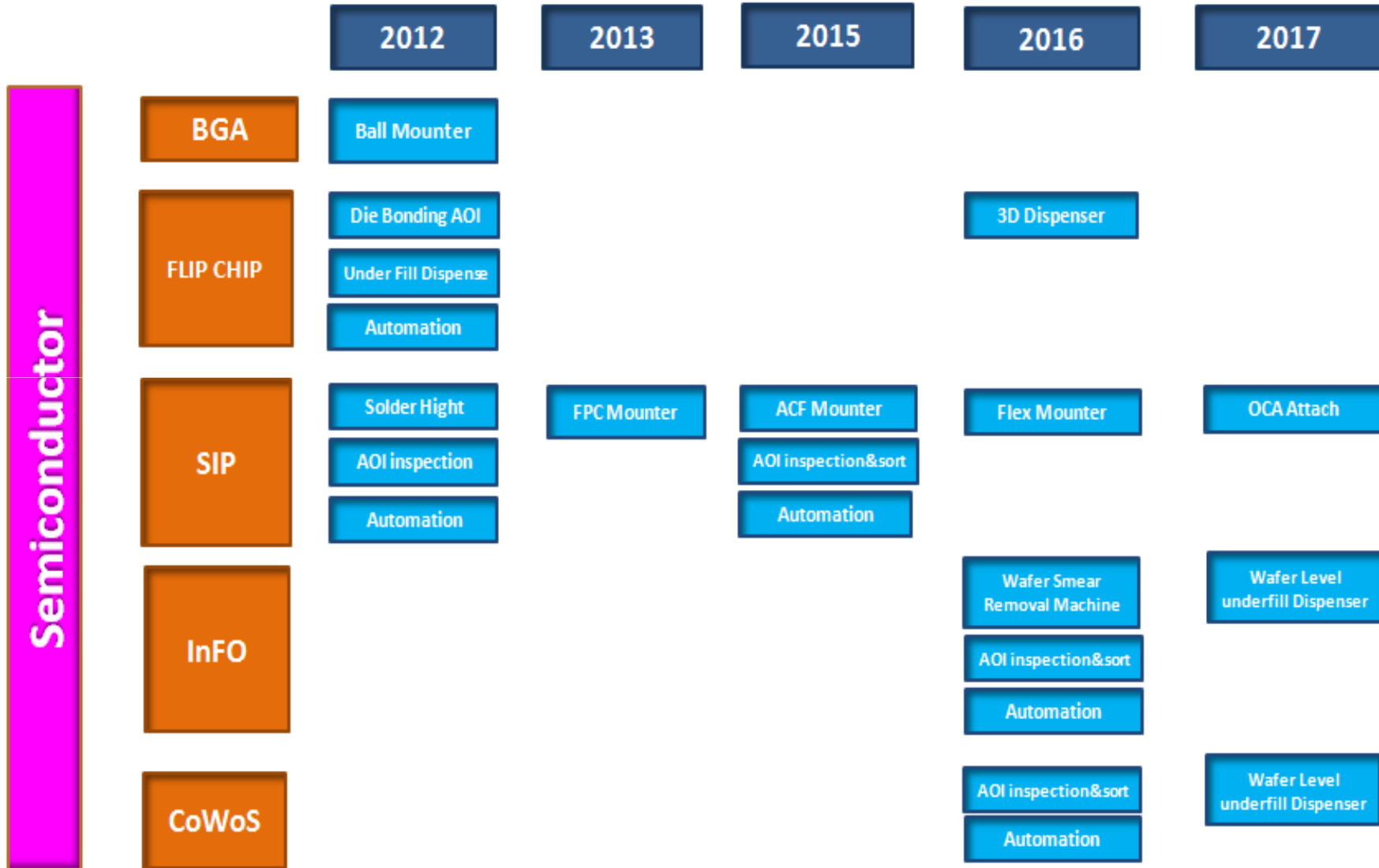
Spray Pump



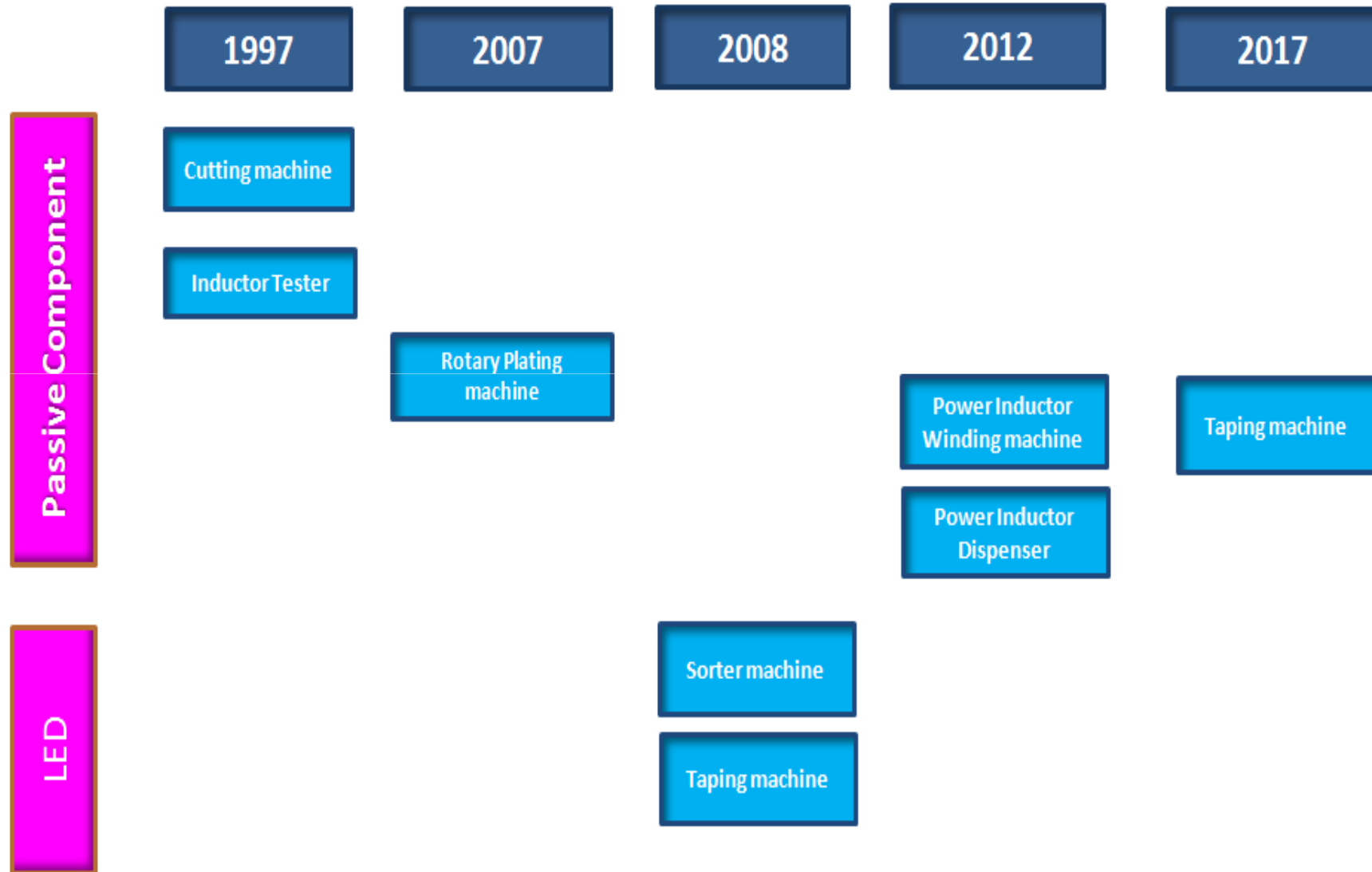
Core Tech – Vision System






























Product Portfolio - Semiconductor



Product Portfolio—Passive Component/LED



Customer Base

Semiconductor	Passive Component	LED
 	  	
 	 	
 	   	 
 	   	 

CSR – Allring Charity Foundation



Care for Employee

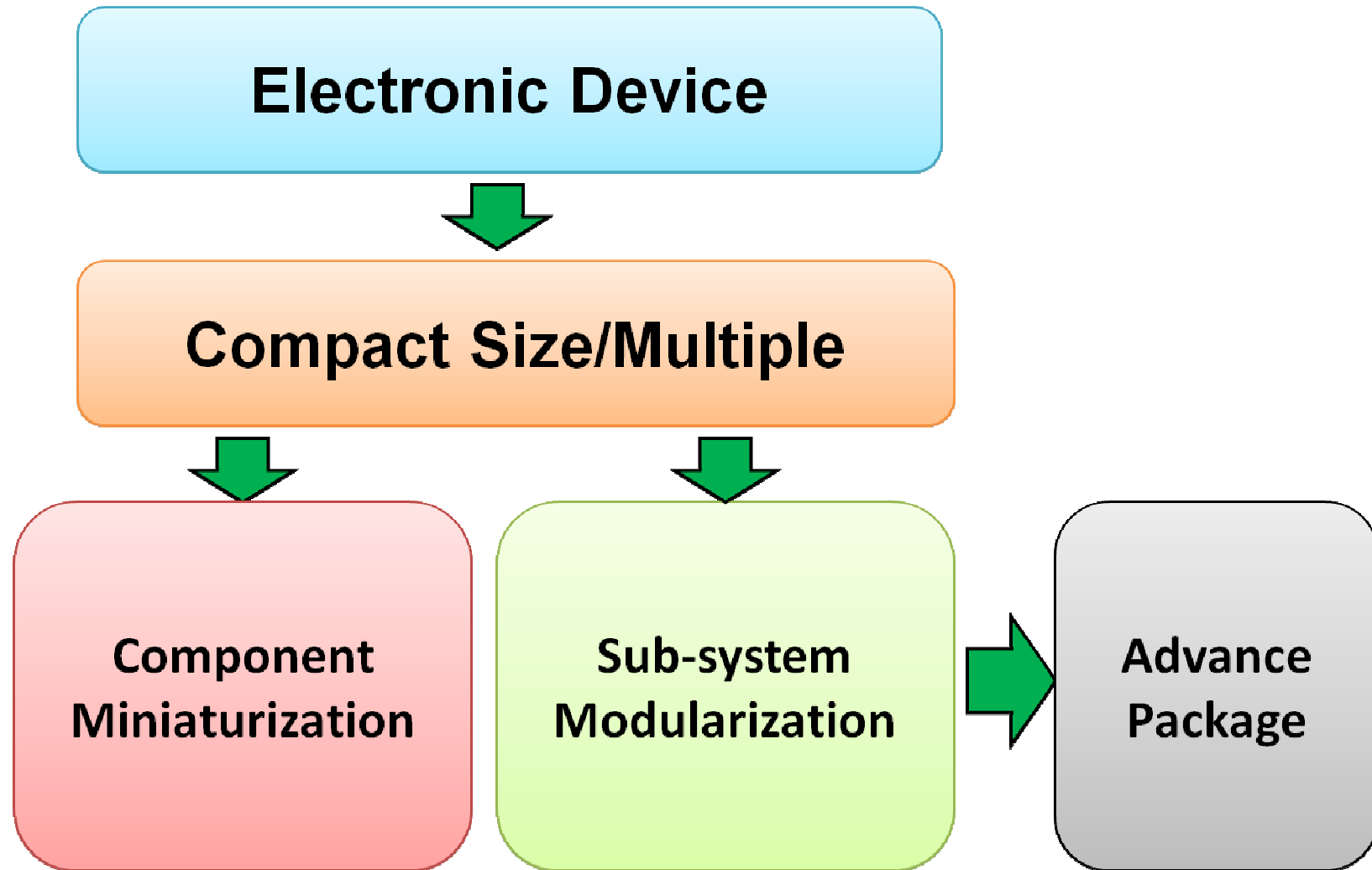
- Top 50 listed companies of 2014 Average Employee Welfare Costs
- Top 50 listed companies of 2015 Best-Paying





産業概況

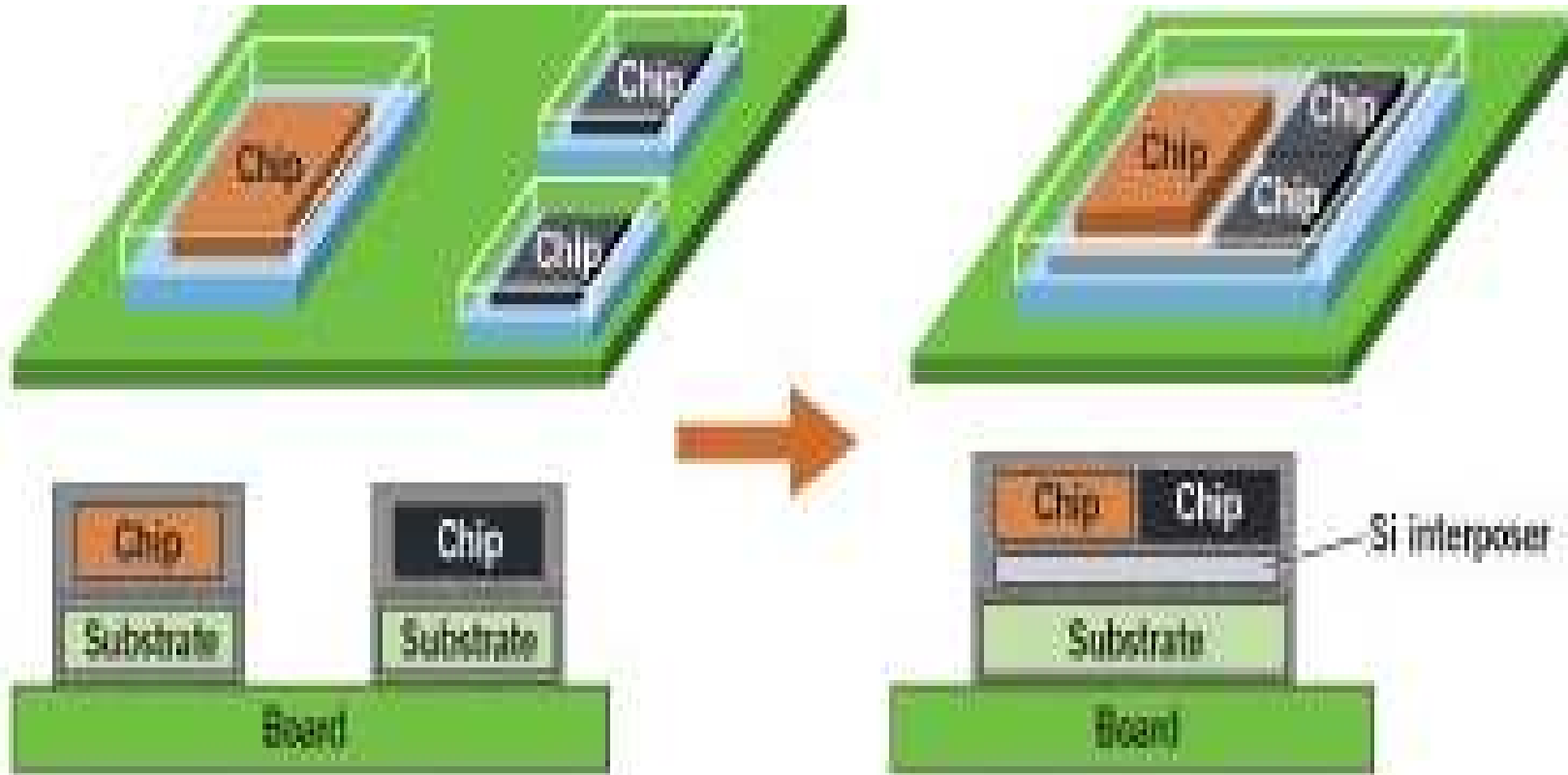
Industry Overview



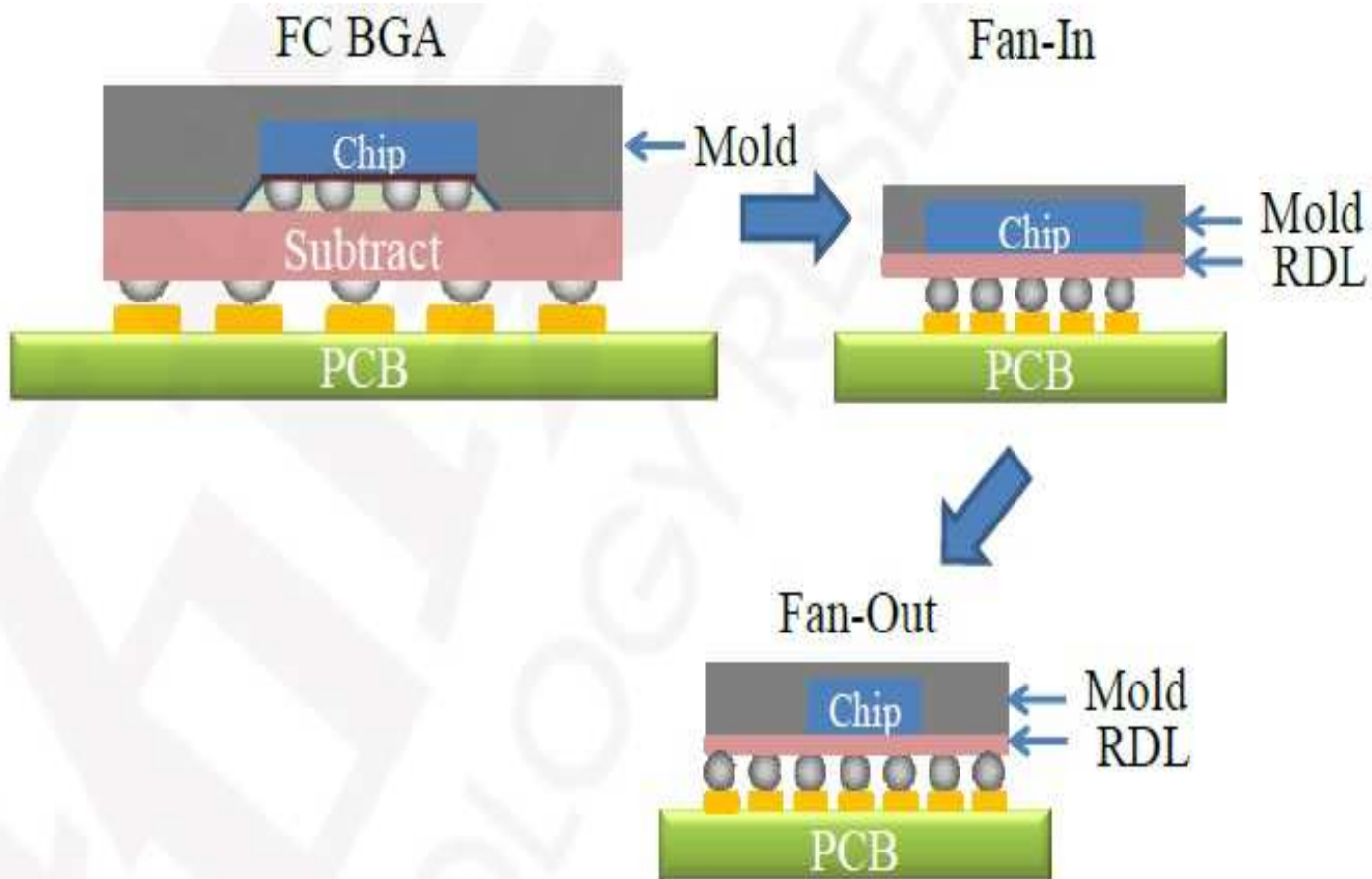
Semi - Advance Package

Packaging Type		Manufacturer		Application
SIP (system in package)		OSAT	ASE	Smart phone IoT Mobile
			USI	
		Module house	Hon Hai	
			Pegatron	
		Component	AAC	
ICT				
WLP (wafer level package)	InFO	Foundry	TSMC	Smart Phone AI 5G
	CoWoS		TSMC	
Flip chip	2.5/3D	OSAT	ASE	Smart Phone IoT Mobile
			Spil	
			Amkor	
			JCET	
			Powertech	

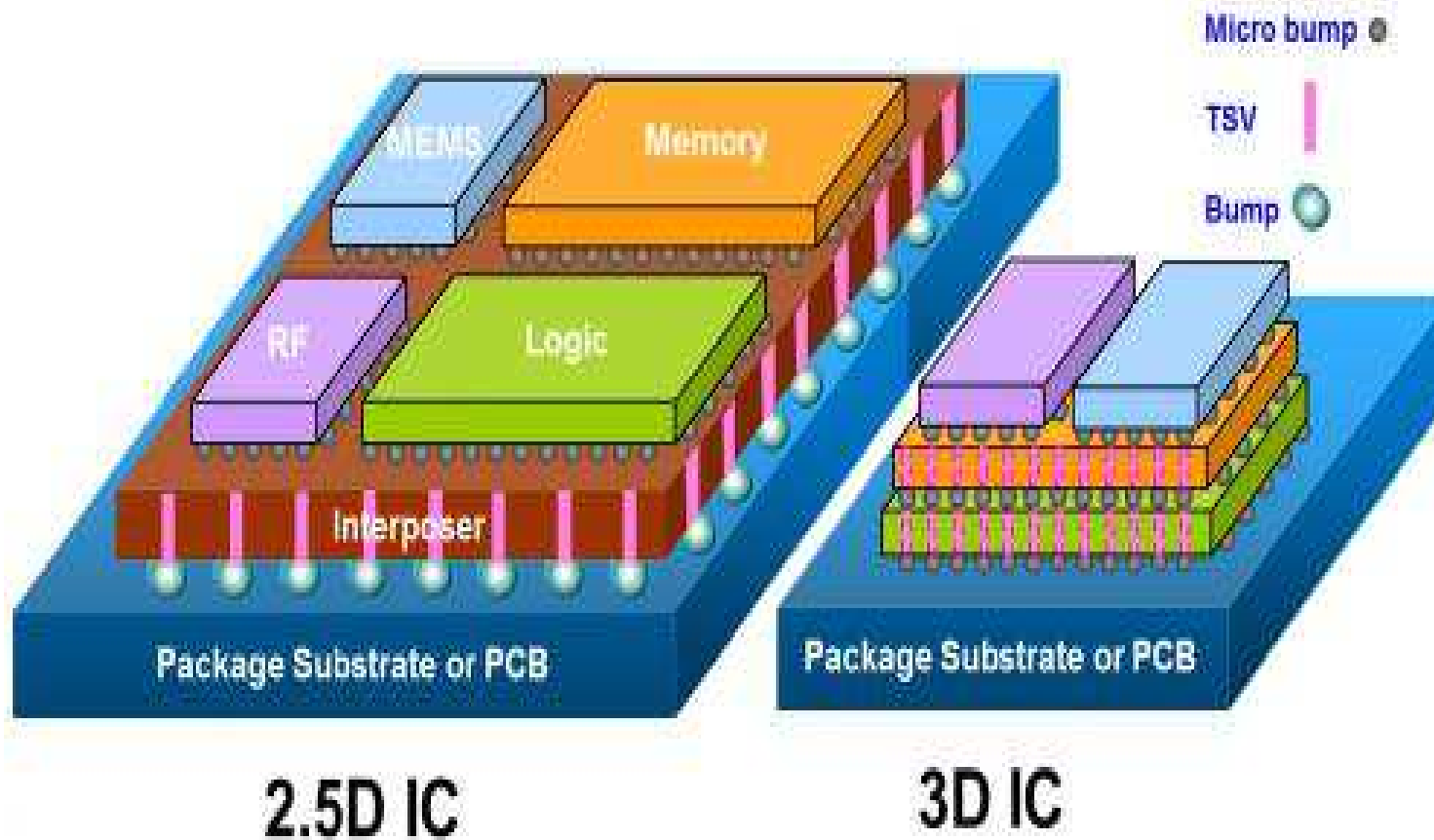
System in Package (SiP)



Flip-chip & wafer-level packaging



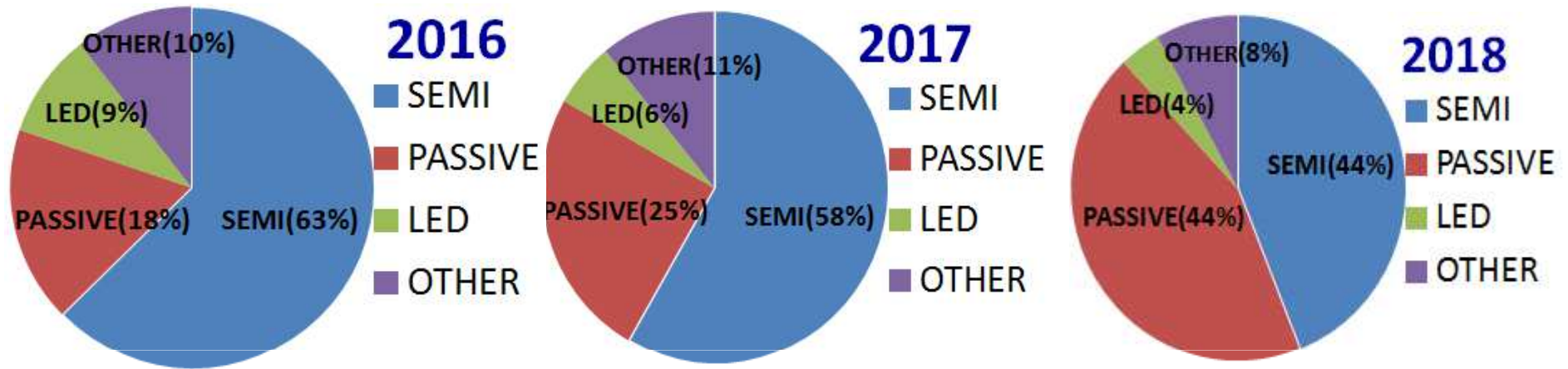
2.5D & 3D IC Packaging





營運表現

Revenue Breakdown



NT\$100M

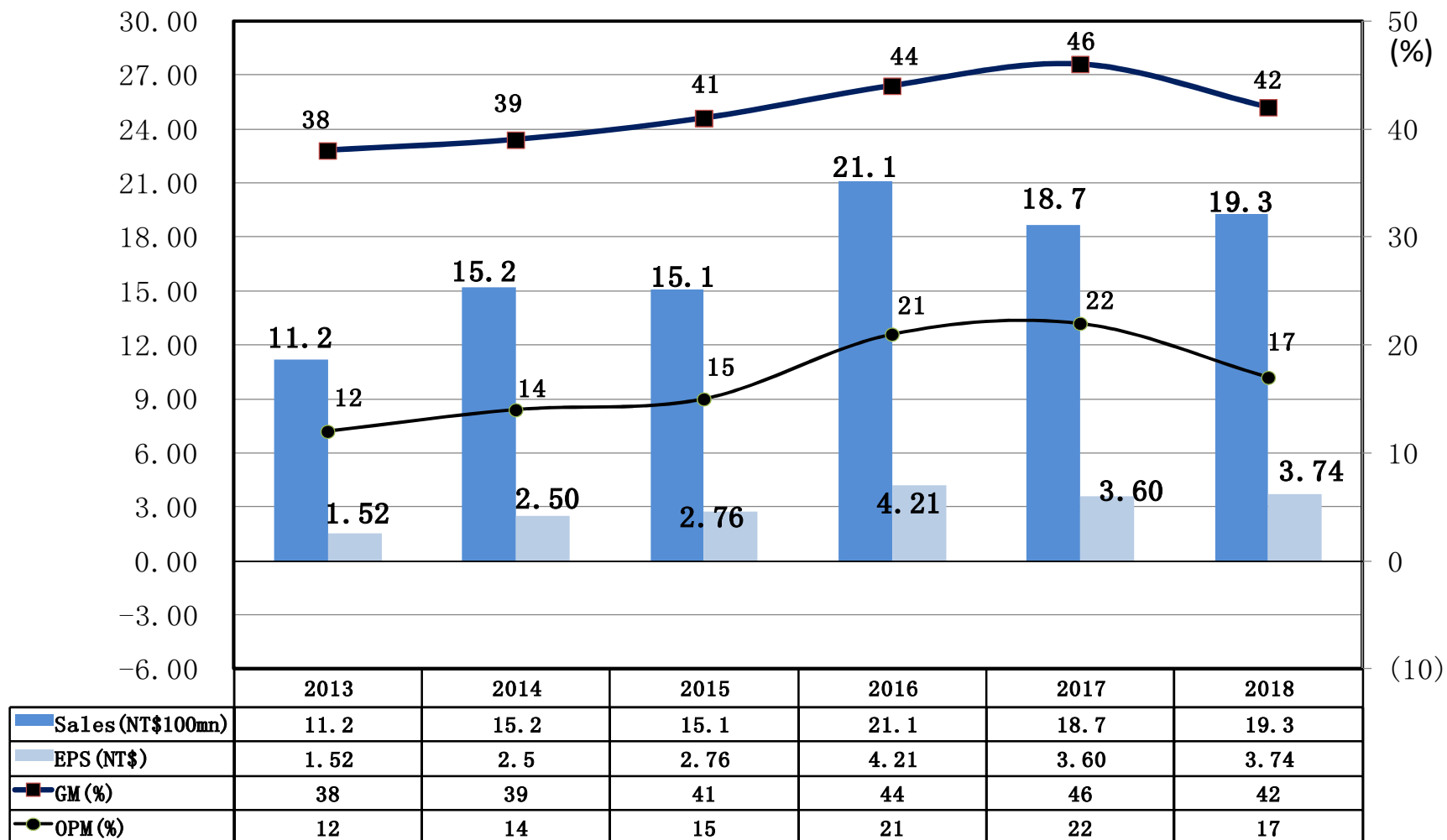
2016

2017

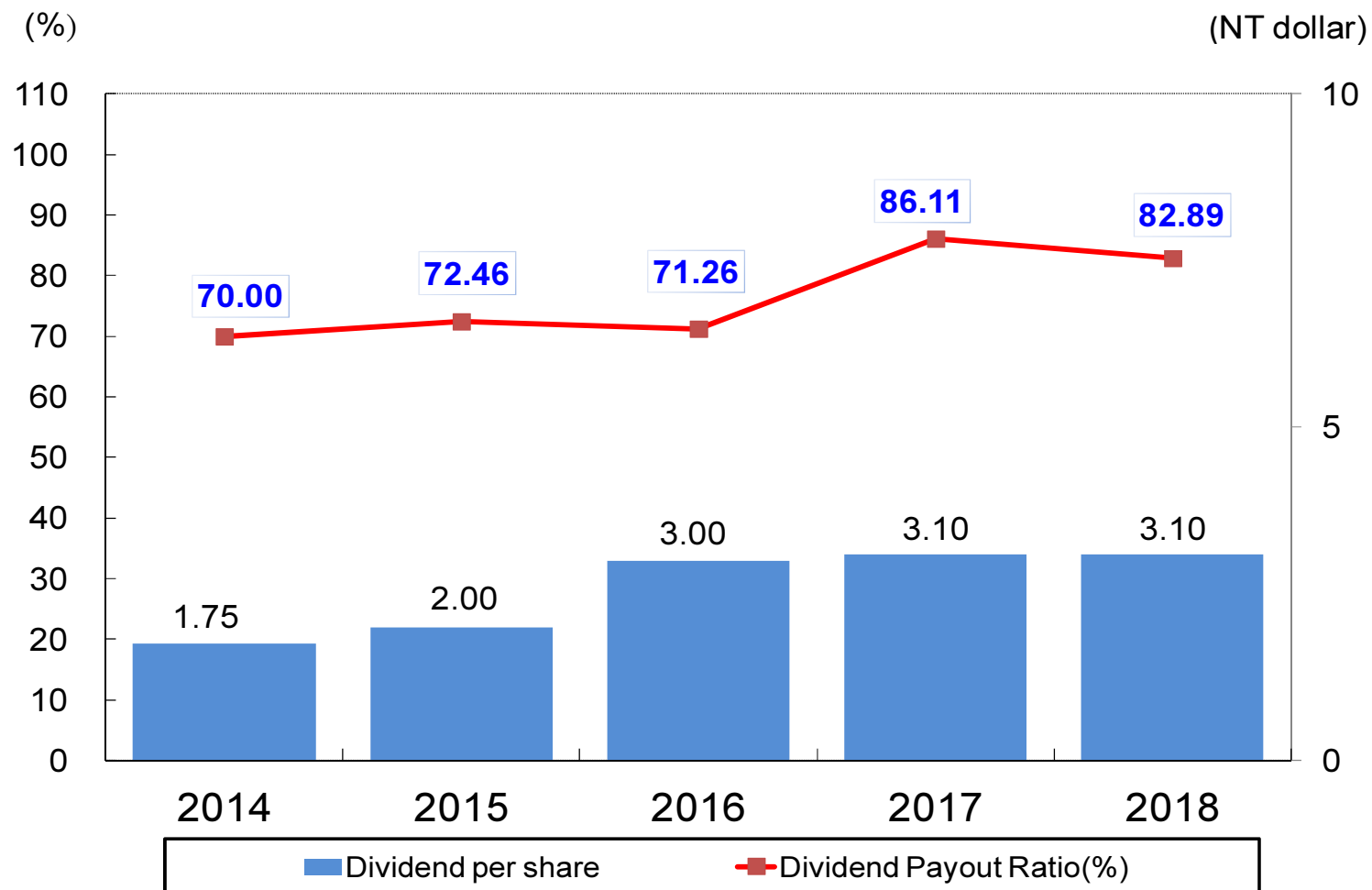
2018

SEMI	13.23	63%	10.89	58%	8.46	44%
PASSIVE	3.70	18%	4.64	25%	8.49	44%
LED	1.97	9%	1.11	6%	0.77	4%
OTHER	2.22	10%	2.03	11%	1.54	8%
TOTAL	21.12	100%	18.67	100%	19.26	100%

Financial Highlights



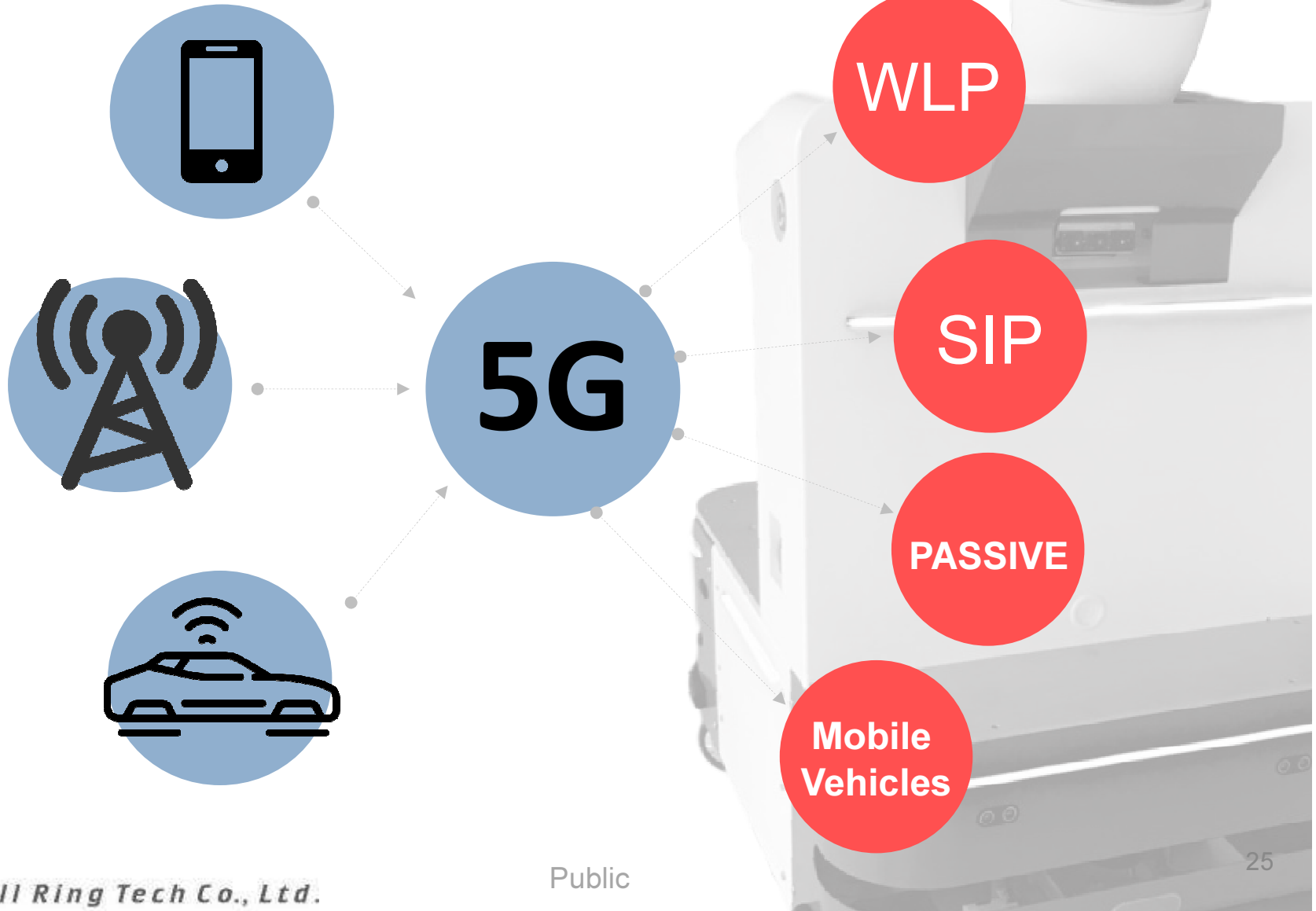
Financial Highlights





未來展望

FUTURE APPLICATION





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Thank you